

### Surface Mount Switching Diode

 Lead(Pb)-Free

#### Features:

- \*High Speed  $\leq 4\text{ns}$
- \*Low Rever Leakage Current
- \*Small Outline Surface Mount SOD-323 Package

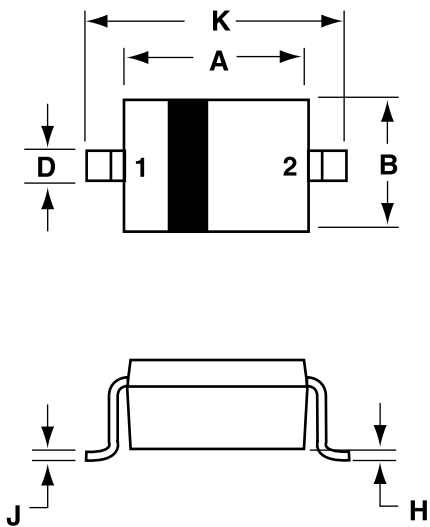
SWITCHING DIODE  
200mAMPERS  
100VOLTS



**SOD-323**

### SOD -323 Outline Dimensions

Unit:mm



| Dim | MILLMETERS |       |
|-----|------------|-------|
|     | Min        | Max   |
| A   | 1.60       | 1.80  |
| B   | 1.15       | 1.35  |
| C   | 0.80       | 1.00  |
| D   | 0.25       | 0.40  |
| E   | 0.15REF    |       |
| H   | 0.00       | 0.10  |
| J   | 0.089      | 0.377 |
| K   | 2.30       | 2.70  |

PIN 1.CATHODE  
2.ANODE

## Maximum Ratings

| Rating                     | Symbol     | Value | Unit |
|----------------------------|------------|-------|------|
| Reverse Voltage            | VR         | 100   | Vdc  |
| Forward Current            | IF         | 200   | mAdc |
| Peak Forward Surge Current | IFM(Surge) | 500   | mAdc |

## Thermal Characteristics

| Characteristics                                                         | Symbol   | Max          | Unit  |
|-------------------------------------------------------------------------|----------|--------------|-------|
| Total Device Dissipation FR-5 Board TA=25°C Derate Above 25°C           | PD       | 225          | mW    |
|                                                                         |          | 1.8          | mW/°C |
| Thermal Resistance, Junction to Ambient                                 | RθJA     | 556          | °C/W  |
| Total Device Dissipation Alumina Substrate,(2)TA=25°C Derate Above 25°C | PD       | 300          | mW    |
|                                                                         |          | 2.4          | mW/°C |
| Thermal Resistance, Junction to Ambient                                 | RθJA     | 417          | °C/W  |
| Junction and Storage Temperature                                        | TJ, Tstg | -55 to + 150 | °C    |

## Electrical Characteristics (TA=25°C Unless Otherwise note)


| Characteristics | Symbol | Min | Max | Unit |
|-----------------|--------|-----|-----|------|
|-----------------|--------|-----|-----|------|

## Off Characteristics

|                                                       |       |     |              |      |
|-------------------------------------------------------|-------|-----|--------------|------|
| Reverse Breakdown Voltage (IR=100μAdc)                | V(BR) | 100 | —            | Vcc  |
| Forward Voltage(IF=10mAdc)                            | VF    | —   | 1000         | mVdc |
| Reverse Voltage Leakage Current (VR=20Vdc) (VR=75Vdc) | IR    | —   | 0.025<br>5.0 | μAdc |
| Diode Capacitance (VR=0, f=1.0MHz)                    | CT    | —   | 4.0          | pF   |
| Reverse Recover Time (IF=IR=10mAdc)                   | trr   | —   | 4.0          | ns   |

1. FR-5=1.0x0.75x0.062 in 2. Alumina=0.4x0.3x0.024 in. 99.5% alumina.

## Device Marking

| Item     | Marking | Equivalent Circuitdiagram                                                             |
|----------|---------|---------------------------------------------------------------------------------------|
| MMBL914H | 5D      |  |

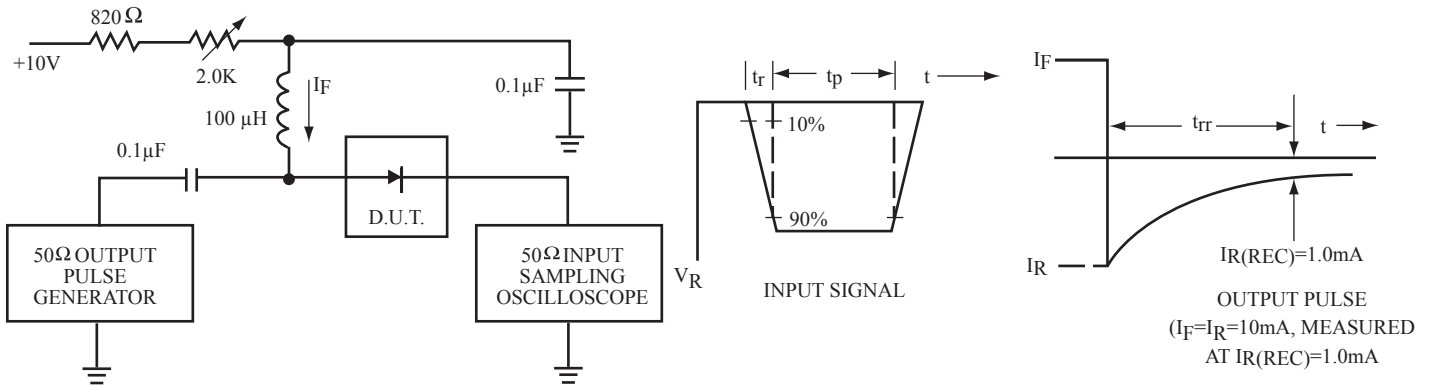


Figure 1. Recovery Time Equivalent Test Circuit

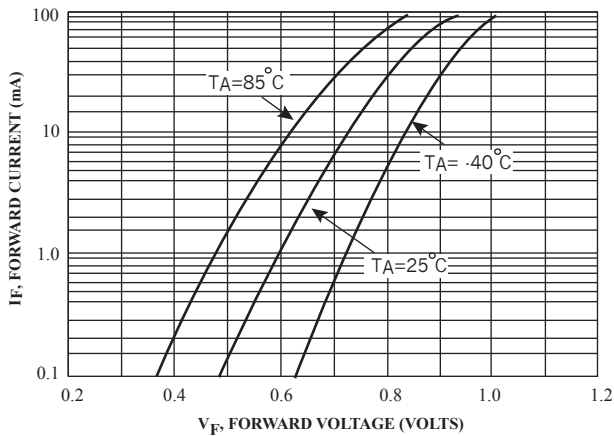


Figure 2. Forward Voltage

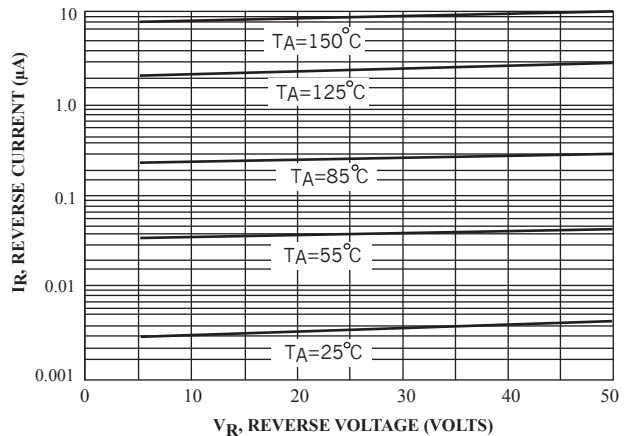


Figure 3. Leakage Current

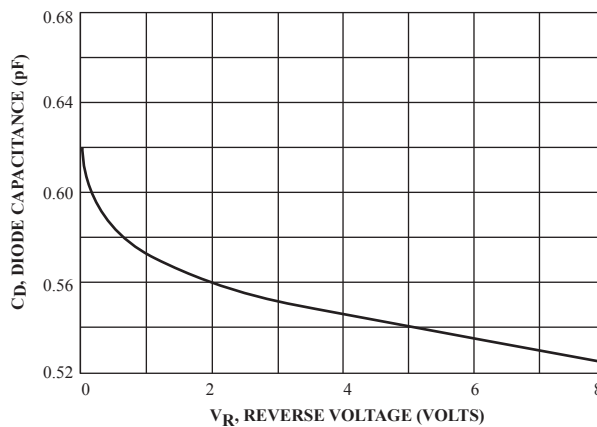


Figure 4. Capacitance